

ISD ChipCorder® ISD15D00 Series Datasheet

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1. GENERAL DESCRIPTION

The ISD15D00 is a digital ChipCorder® featuring digital compression, comprehensive memory management, and integrated analog/digital audio signal paths. The ISD15D00 utilizes serial flash memory to provide non-volatile audio playback for a two-chip solution. The ISD15D00 provides an I²S digital audio interface, faster digital programming, higher sampling frequency, and a signal path with SNR 80dB.

The ISD15D00 can take digital audio data via I²S or SPI interface. When I²S input is selected, it will replace the analog audio inputs and will support sample rates of 32, 44.1 or 48 kHz depending upon clock configuration. When SPI interface is chosen, the sample rate of the audio data sent must be one of the ISD15D00 supported sample rates.

The ISD15D00 has inbuilt analog audio inputs, analog audio line driver, and speaker driver output.

The analog audio input, Aux-in, has a fixed gain configured by SPI command. Aux-in can directly feed-through to the analog outputs; it can also mix with the DAC output and then feed-through to the analog outputs.

The ISD15D00 can deliver three kinds output: 1) Aux-out, an analog single-ended voltage output; 2) Class-AB BTL (bridge-tied-load) analog differential voltage output; 3) Class-D PWM. Both Class-AB BTL and Class-D PWM output can directly drive a speaker.

2. FEATURES

- External Memory:
 - The ISD15D00 supports the following flash:

| Manufacturer | Winbond | | Numonyx | | | MXIC |
|--------------|----------|----------|----------|----------|----------|-----------|
| Family | 25X | 25Q | 25P | 25PX | 25PE | 25L / 25V |
| JEDEC ID | EF 30 1X | EF 40 1X | 20 20 1X | 20 71 1X | 20 80 1X | C2 20 1X |

- The addressing ability of ISD15D00 is up to 128Mbit, which is 64-minute playback time based on 8kHz/4bit ADPCM.
- Inbuilt 3V voltage regulator to provide power source to the external flash memory
- Fast Digital Programming
 - Programming rate can go up to 1Mbits/second mainly limited by the flash memory write rate.
- Memory Management
 - Store pre-recorded audio (Voice Prompts) using high quality digital compression
 - Use a simple index-based command for playback
 - Execute pre-programmed macro scripts (Voice Macros) designed to control the configuration of the device and play back Voice Prompts sequences.
- Sample Rate
 - Seven sampling frequencies are available for a given master sample rate. For example, the sampling frequencies of 4, 5.3, 6.4, 8, 12.8, 16 and 32kHz are available when the device is clocked at a 32kHz master sample rate.
 - For I²S operation, 32, 44.1 and 48kHz master sample rates are available with playback sampling frequencies scaling accordingly.
- Compression Algorithm
 - For Pre-Recorded Voice Prompts
 - μ -Law: 6, 7 or 8 bits per sample
 - Differential μ -Law: 6, 7 or 8 bits per sample
 - PCM: 8, 10 or 12 bits per sample
 - Enhanced ADPCM: 2, 3, 4 or 5 bits per sample
 - Variable-bit-rate optimized compression. This allows best possible compression given a metric of SNR and background noise levels.

- Oscillator
 - Internal oscillator with internal reference: 2.048 MHz with $\pm 1\%$ deviation
 - Internal oscillator with external resistor: 2.048 MHz with $\pm 2\%$ deviation¹
 - I²S bit clock input
- Input
 - Aux-in: Analog input with 2-bit gain control configured by SPI command
- Output
 - Aux-out: an analog single-ended voltage output
 - Class-D PWM speaker driver, capable of delivering typical power:
 - 4 Ω load: 1W @5.5V; 335mW @3.3V.
 - 8 Ω load: 930mW @5.5V; 320mW @ 3.3V.
 - Class-AB BTL analog differential output, capable of delivering typical power:
 - 4 Ω load: 950mW @5.5V; 330mW @3.3V.
 - 8 Ω load: 930mW @5.5V; 320mW @ 3.3V.
- I/O
 - SPI interface: MISO, MOSI, SCLK, SSB for commands and digital audio data
 - I²S interface: I²S_CLK, I²S_WS, I²S_SDI, I²S_SDO for digital audio data
 - 8 GPIO pins:
 - 4 GPIO pins share with I²S
 - 4 GPIO pins share with SPI Interface
 - GPIO pins can trigger Voice Macro for a pushbutton application
- 8-bit Volume Control set by SPI command for flexible mixing
- Talarm temperature threshold: 125°C typical
- Operating Voltage: 2.7 ~ 5.5V
- Standby Current: 1uA typical
- Package:
 - Green 32L-QFN
- sAutomotive grade:
 - AEC-Q100 grade 3 operating temperature range -40°C to 85°C
 - Tested to a high reliability standard²

¹ With $\pm 1\%$ precision 80kohm external resistor.

² Contact Nuvoton sales representatives for details.

3. BLOCK DIAGRAM

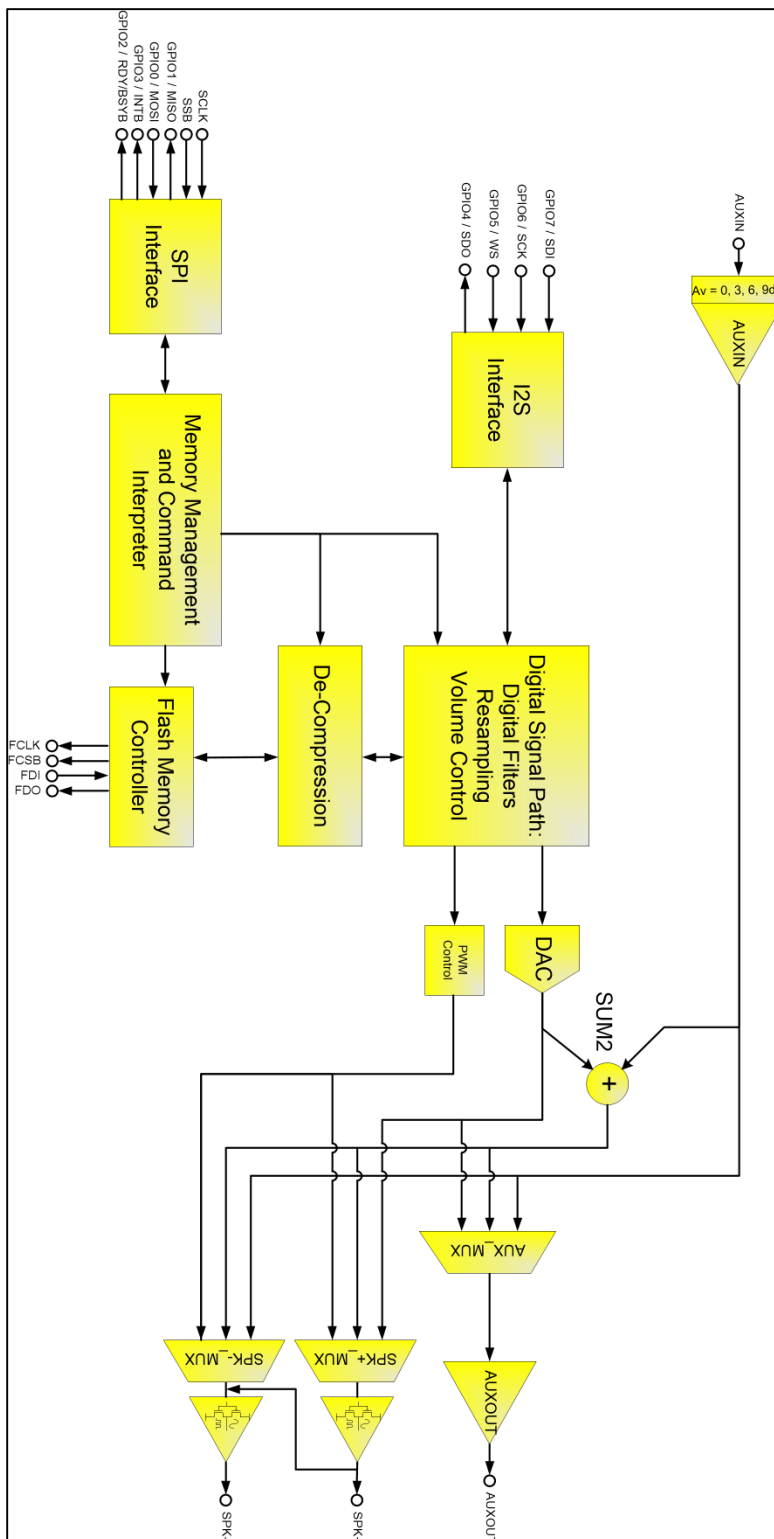


Figure 3-1 ISD15D00 Block Diagram

4. PINOUT CONFIGURATION

3.1 32L-QFN

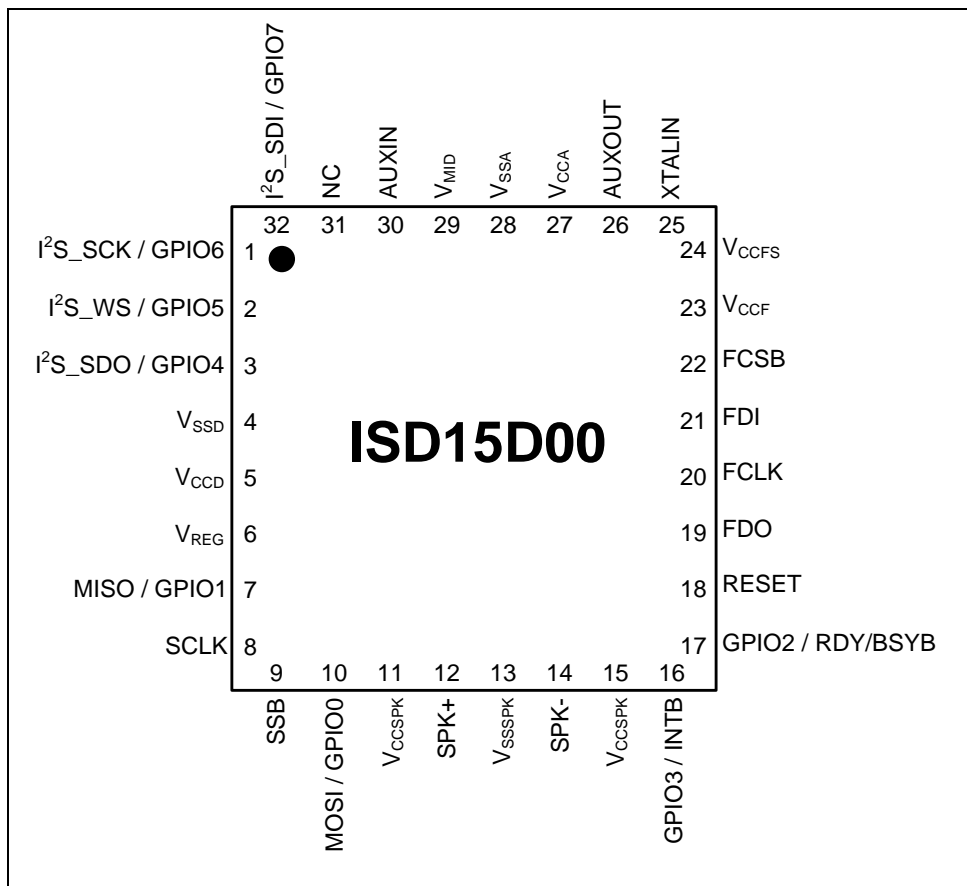


Figure 4-1 ISD15D00 32-Lead QFN Pin Configuration

5. PIN DESCRIPTION

| Pin Name | I/O | | Function |
|----------|------------------------------|-----|---|
| QFN-32 | | | |
| 1 | GPIO6 / I ² S_SCK | I/O | A GPIO pin. By default this pin is a pull-high input. Can be configured as Clock input in slave mode or clock output in master mode. This pin can be configured as an external clock buffer if I ² S is not used. |
| 2 | GPIO5 / I ² S_WS | I/O | A GPIO pin. By default this pin is a pull-high input. Can be configured as Word Select (WS) input in slave mode or WS output in master mode. |
| 3 | GPIO4 / I ² S_SDO | I/O | A GPIO pin. By default this pin is a pull-high input. Can be configured as Serial Data Output of the I ² S Interface. |
| 4 | V _{SSD} | I | Digital Ground. |
| 5 | V _{CCD} | I | Digital power supply. |
| 6 | V _{REG} | O | A 1.8V regulator to supply the internal logic. A minimum 1uF capacitor with low ESR<0.5OHM should be connected to this pin for supply decoupling and stability. |
| 7 | GPIO1 / MISO | O | Master-In-Slave-Out. Serial output from the ISD15D00 to the host. This pin is in tri-state when SSB=1. Can be configured as GPIO1. |
| 8 | SCLK | I | Serial Clock input to the ISD15D00 from the host. |
| 9 | SSB | I | Slave Select input to the ISD15D00 from the host. When SSB is low device is selected and responds to commands on the SPI interface. |
| 10 | GPIO0 / MOSI | I | Master-Out-Slave-In. Serial input to the ISD15D00 from the host. Can be configured as GPIO0. |
| 11 | V _{CCSPK} | I | Power supply for speaker driver. |
| 12 | SPK+ | O | PWM driver positive output. This SPK+ output, together with SPK-pin, provide a differential output to drive a speaker. During power down this pin is in tri-state. Or, can be configured as Class-AB BTL which, together with SPK-pin, provides a differential voltage output. Or, can be configured as a Class-AB single-ended output. |
| 13 | V _{SSSPK} | I | In PWM mode: Digital Ground for the PWM Driver. Or, In Class-AB mode: Analog Ground for the Class-AB output. |
| 14 | SPK- | O | PWM driver negative output. This SPK- output, together with SPK+ pin, provides a differential output to drive a speaker. During power down this pin is tri-state. Or, can be configured as Class-AB BTL which, together with SPK+ pin, provides a differential voltage output. Or, can be configured as a Class-AB single-ended output. |
| 15 | V _{CCSPK} | I | Power supply for speaker driver. |

| Pin Name | I/O | | Function |
|----------|------------------------------|-----|--|
| QFN-32 | | | |
| 16 | GPIO3 / INTB | O | Active low interrupt request pin. This pin is an open-drain output. Can be configured as GPIO3. |
| 17 | GPIO2 / RDY/ BSYB | O | An output pin to report the status of data transfer on the SPI interface. "High" indicates that ISD15D00 is ready to accept new SPI commands or data. Can be configured as GPIO2. |
| 18 | RESET | I | Applying power to this pin will reset the chip. (A high pulse of 50ms or more will reset the chip.) |
| 19 | FDO | O | Serial data output of the external serial flash interface. Connects to data input (DI) of external serial flash. |
| 20 | FCLK | O | Serial data CLK of the external serial flash interface. |
| 21 | FDI | I | Serial data input to external serial flash interface. Connects to data output (DO) of external flash memory. |
| 22 | FCSB | O | Chip Select Bar of the external serial flash interface. |
| 23 | V _{CCF} | O | Digital power supply for the external flash memory. A minimum 1uF capacitor with low ESR<0.5OHM should be connected to this pin for supply decoupling and stability. Refer to the application diagram. |
| 24 | V _{CCFS} | I | Digital power supply for the inbuilt voltage regulator for the external flash memory. A 0.1uF capacitor should be connected to this pin for supply decoupling and stability. Refer to the application diagram. |
| | XTALOUT | O | Crystal interface output pin. |
| 25 | XTALIN | I | The CLK_CFG register determines one of the following three configurations: (1) A crystal or resonator connected between the XTALOUT and XTALIN pins. (2) A resistor connected to GND as a reference current to the internal oscillator and left the XTALOUT unconnected. (3) An external clock input to the device and left the XTALOUT unconnected. |
| 26 | AUXOUT | O | Aux Output. This pin is an analog voltage output. If AUXOUT is not used, this pin should be left unconnected. |
| 27 | V _{CCA} | I | Analog power supply pin. |
| 28 | V _{SSA} | I | Analog ground pin. |
| 29 | V _{MID} | O | Middle voltage reference for the swing of analog/digital audio outputs. A 4.7uF capacitor should be connected to this pin for supply decoupling and stability. |
| 30 | AUXIN | I | Auxiliary input with the gain set by SPI command. If Aux-in is not used, this pin should be left unconnected. |
| 31 | NC | | This pin should be left unconnected. |
| 32 | GPIO7 / I ² S_SDI | I/O | A GPIO pin. By default this pin is a pull-high input. Can be configured as Serial Data Input of the I ² S interface. |

*note: for QFN-32 package center pad underneath should be connected to VSSA. Please avoid placing exposed via under this pad.

6. ELECTRICAL CHARACTERISTICS

5.1 ABSOLUTE MAXIMUM RATINGS

| DESCRIPTION | SYMBOL | CONDITION | MIN | MAX | UNIT |
|-----------------------|-------------|-------------------------|-----------------|-----------------|------|
| DC Power Supply | V_{CCD} | $V_{CCD} - V_{SSD}$ | -0.3 | +6.0 | V |
| | V_{CCA} | $V_{CCA} - V_{SSA}$ | -0.3 | +6.0 | V |
| | V_{CCSPK} | $V_{CCSPK} - V_{SSSPK}$ | -0.3 | +6.0 | V |
| Digital Input Voltage | DV_{IN} | $DV_{IN} - V_{SSD}$ | $V_{SSD} - 0.3$ | $V_{CCD} + 0.3$ | V |
| Analog Input Voltage | AV_{IN} | $AV_{IN} - V_{SSA}$ | $V_{SSA} - 0.3$ | $V_{CCA} + 0.3$ | V |
| Junction Temperature | T_J | - | -40 | +125 | °C |
| Storage Temperature | T_{st} | - | -65 | +150 | °C |

CAUTION: Do not operate at or near the maximum ratings listed for extended period of time. Exposure to such conditions may adversely influence product reliability and result in failures not covered by warranty. These devices are sensitive to electrostatic discharge; follow proper IC Handling Procedures.

5.2 OPERATING CONDITIONS

OPERATING CONDITIONS (INDUSTRIAL PACKAGED PARTS)

| CONDITION | VALUE |
|---|-----------------|
| Operating temperature range (Case temperature) | -40°C to +85°C |
| Digital Supply voltage (V_{CCD}) ^[1] | +2.7V to +5.5V |
| Digital Ground voltage (V_{SSD}) ^[2] | 0V |
| Analog Supply voltage (V_{CCA}) ^[3] | +2.7V to +5.5V |
| Analog Ground voltage (V_{SSA}) ^[2] | 0V |
| Speaker Supply voltage (V_{CCSPK}) ^[3] | +2.7V to +5.5V |
| Speaker Ground voltage (V_{SSSPK}) ^[2] | 0V |
| Flash Source Supply voltage (V_{CCFS}) ^[4] – to regulate V_{CCF} | +2.7V to +5.5V |
| Flash Source Supply voltage (V_{CCFS}) ^[4] – tied to V_{CCF} | +2.25V to +3.6V |
| Flash Supply voltage - (V_{CCF}) ^[4] – regulated from V_{CCFS} | +2.4V to +3.0V |
| Flash Supply voltage - (V_{CCF}) ^[4] – tied to V_{CCFS} | +2.25V to +3.6V |

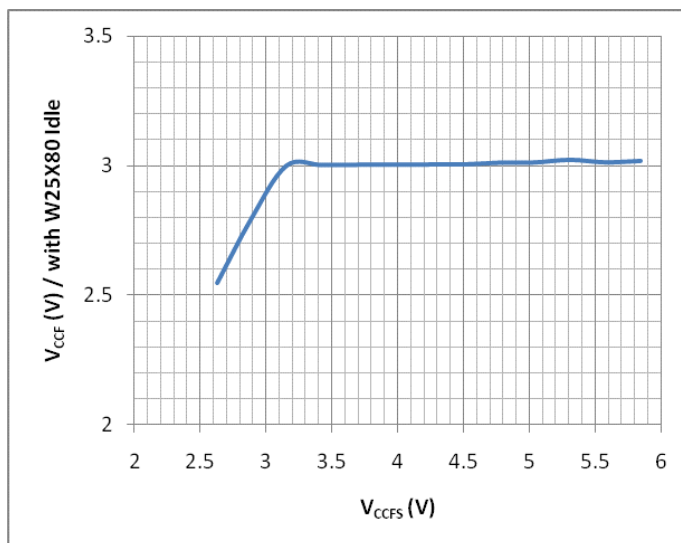


Figure 6-1 V_{CCF} vs. V_{CCFS} – V_{CCF} is regulated internally from V_{CCFS} ^[4]

NOTES:

^[1] V_{CCD} 2.7 ~ 5.5V; No restrictions with respect to V_{CCA} and V_{CCSPK} .

^[2] $V_{SSD} = V_{SSA} = V_{SSSPK}$

^[3] In Class-AB mode: V_{CCSPK} must equal V_{CCA} . Otherwise: $V_{CCSPK} \geq V_{CCA}$.

^[4] If V_{CCFS} is guaranteed to be below 3.6V (or upper flash supply limit), then V_{CCF} should be tied to V_{CCFS} .

5.3 DC PARAMETERS

| PARAMETER | SYMBOL | MIN | TYP [1] | MAX | UNIT S | CONDITIONS |
|---|--------------------|----------------------|------------------|----------------------|-----------|---|
| Digital Supply Voltage | V_{CCD} | 2.7 | | 5.5 | V | |
| Analog Supply Voltage | V_{CCA} | 2.7 | | 5.5 | V | |
| Speaker Supply Voltage | V_{CCSPK} | 2.7 | | 5.5 | V | |
| Flash Source Supply Voltage | V_{CCFS} | 2.7 | | 5.5 | V | to regulate V_{CCF} |
| | | 2.25 | | 3.6 | | tied to V_{CCF} |
| Flash Supply Voltage (refer to Figure 6-1) | V_{CCF} | | $V_{CCFS} - 0.3$ | | V | regulated from V_{CCFS} $V_{CCFS} = 2.7 \sim 3.3V$ |
| | | | 3.0 | | | regulated from V_{CCFS} $V_{CCFS} = 3.3 \sim 5.5V$ |
| | | 2.25 | | 3.6 | | tied to V_{CCFS} |
| Input Low Voltage | V_{IL} | $V_{SSD} - 0.3$ | | $0.3 \times V_{CCD}$ | V | |
| Input High Voltage | V_{IH} | $0.7 \times V_{CCD}$ | | V_{CCD} | V | |
| Output Low Voltage | V_{OL} | $V_{SSD} - 0.3$ | | $0.3 \times V_{CCD}$ | V | $I_{OL} = 1mA$ |
| Output High Voltage | V_{OH} | $0.7 \times V_{CCD}$ | | V_{CCD} | V | $I_{OH} = -1mA$ |
| INTB Output Low Voltage | V_{OH1} | | | 0.4 | V | |
| Playback Current | $I_{DD_Playback}$ | | 10 | 30 | mA | No load |
| Standby Current | I_{SB} | | 1 | 10 | μA | $V_{CCD} = 3.0V$ |
| Input Leakage Current | I_{IL} | -1 | | +1 | μA | Force V_{CCD} |

Notes: [1] Conditions $V_{CCD}=V_{CCA}=V_{CCSPK}=V_{CCFS}=3V$, $T_A=25^{\circ}C$ unless otherwise stated

5.4 AC PARAMETERS

5.4.1 Internal Oscillator

| Parameter | Symbol | Min | Typ. | Max | Unit | CONDITION |
|---|--------|-----|-----------|-----|------|--|
| Internal oscillator with internal reference | FINT | -1% | 2.048 MHz | +1% | MHz | $V_{CCD} = 3.3V$. At room temperature. |
| Internal oscillator with external reference | FEXT | -2% | 2.048 MHz | +2% | MHz | With $\pm 1\%$ precision resistor, 80kohm. $V_{CCD} = 3.3V$. At room temperature. |

5.4.2 Inputs

AUX-IN:

Conditions: $V_{CCD} = 3.3V$, $V_{CCA} = V_{CCSPK}$, $MCLK = 16.384MHz$, $T_A = +25^{\circ}C$, 1kHz signal

| Parameter | Symbol | Comment/Condition | Min | Typ. | Max | Unit |
|--|----------------------|--|--------|----------------------|--------|--|
| Auxiliary Analog Inputs (AUXIN) | | | | | | |
| Full scale input signal | | Gain = 0dB | | 1.0 0 | | Vrms dBV |
| AUX Programmable gain | | | 0 | | 9 | dB |
| AUX programmable gain step size | | Guaranteed Monotonic | | 3 | | dB |
| Input resistance | Raux_in | Aux direct-to-out path: Input gain = +9.0dB Input gain = +6.0dB Input gain = +3.0dB Input gain = 0dB | | 21 27 33 40 | | k Ω k Ω k Ω k Ω |
| Aux-in Gain Accuracy | A _{AUX(GA)} | | -0.5dB | | +0.5dB | dB |

Note: $V_{CCA} = V_{CCSPK} = 3.3V$ or $V_{CCA} = V_{CCSPK} = 5.0V$

5.4.3 Outputs

AUX-OUT

Conditions: $V_{CCD} = 3.3V$, $V_{CCA} = V_{CCSPK} = 5V$, 16KHz Sample rate, PCM12, $T_A = +25^{\circ}C$, 1kHz signal

| Parameter | Symbol | Comment/Condition | Min | Typ. | Max | Unit |
|---|--------|---|-----|-----------------|-----|-----------|
| Digital to Analog Converter (DAC) driving AUXOUT with 5kΩ / 100pF load | | | | | | |
| Full-scale output ¹ | | Gain paths all at 0dB gain | | $V_{CCA} / 3.3$ | | V_{rms} |
| Signal-to-noise ratio | SNR | A-weighted | | 85 | | dB |
| Total harmonic distortion ² | THD+N | $R_L = 5k\Omega$; full-scale signal A-weighted | | -80 | | dB |

Conditions: $V_{CCD} = 3.3V$, $V_{CCA} = V_{CCSPK} = 3.3V$, 16KHz Sample rate, PCM12, $T_A = +25^{\circ}C$, 1kHz signal

| Parameter | Symbol | Comment/Condition | Min | Typ. | Max | Unit |
|---|--------|---|-----|-----------------|-----|-----------|
| Digital to Analog Converter (DAC) driving AUXOUT with 5kΩ / 100pF load | | | | | | |
| Full-scale output ¹ | | Gain paths all at 0dB gain | | $V_{CCA} / 3.3$ | | V_{rms} |
| Signal-to-noise ratio | SNR | A-weighted | | 80 | | dB |
| Total harmonic distortion ² | THD+N | $R_L = 5k\Omega$; full-scale signal A-weighted | | -77 | | dB |

PWM OUTPUT

Conditions: $V_{CCD} = 3.3V$, $V_{CCA} = V_{CCSPK} = 5V$, 16KHz Sample rate, PCM12, $T_A = +25^{\circ}C$, 1kHz signal, 8 Ω load

| Parameter | Symbol | Comment/Condition | Min | Typ. | Max | Unit |
|--|-----------|-----------------------------|-----|------|-----|------|
| Signal-to-noise ratio ³ | SNR | A-weighted + Class D Filter | | 65 | | dB |
| Total harmonic distortion ² | THD | A-weighted + Class D Filter | | -40 | | dB |
| Efficiency | E_{PWM} | 8 Ω bridge-tied-load | | 85 | | % |

Conditions: $V_{CCD} = 3.3V$, $V_{CCA} = V_{CCSPK} = 3.3V$, 16KHz Sample rate, PCM12, $T_A = +25^{\circ}C$, 1kHz signal, 8 Ω load

| Parameter | Symbol | Comment/Condition | Min | Typ. | Max | Unit |
|--|-----------|-----------------------------|-----|------|-----|------|
| Signal-to-noise ratio ³ | SNR | A-weighted + Class D Filter | | 65 | | dB |
| Total harmonic distortion ² | THD | A-weighted + Class D Filter | | -40 | | dB |
| Efficiency | E_{PWM} | 8 Ω bridge-tied-load | | 80 | | % |

CLASS-AB BTL OUTPUT

Conditions: $V_{CCD} = 3.3V$, $V_{CCA} = V_{CCSPK} = 5V$, 16KHz Sample rate, PCM12, $T_A = +25^{\circ}C$, 1kHz signal, 8 Ω load

| Parameter | Symbol | Comment/Condition | Min | Typ. | Max | Unit |
|--|----------|-----------------------------|-----|-----------------|-----|-----------|
| Full scale output ¹ | | Gain paths all at 0dB gain | | $V_{CCA} / 3.3$ | | V_{rms} |
| Signal-to-noise ratio | SNR | A-weighted | | 90 | | dB |
| Total harmonic distortion ² | THD | A-weighted | | -60 | | dB |
| Efficiency | E_{AB} | 8 Ω bridge-tied-load | | 50 | | % |

Conditions: $V_{CCD} = 3.3V$, $V_{CCA} = V_{CCSPK} = 3.3V$, 16KHz Sample rate, PCM12, $T_A = +25^{\circ}C$, 1kHz signal, 8 Ω load

| Parameter | Symbol | Comment/Condition | Min | Typ. | Max | Unit |
|--|----------|-----------------------------|-----|-----------------|-----|-----------|
| Full scale output ¹ | | Gain paths all at 0dB gain | | $V_{CCA} / 3.3$ | | V_{rms} |
| Signal-to-noise ratio | SNR | A-weighted | | 84 | | dB |
| Total harmonic distortion ² | THD | A-weighted | | -60 | | dB |
| Efficiency | E_{AB} | 8 Ω bridge-tied-load | | 50 | | % |

Notes:

1. Full Scale is relative to the magnitude of V_{CCA} and can be calculated as $FS = V_{CCA}/3.3$.
2. Distortion is measured in the standard way as the combined quantity of distortion products plus noise. The signal level for distortion measurements is at 3dB below full scale, unless otherwise noted.
3. SNR measured with a -100dbFS signal at input.

SPEAKER OUTPUT POWER

Conditions: $V_{CCD} = 3.3V$, 16KHz sample rate, 12bit PCM, $T_A = +25^{\circ}C$, 1kHz signal

| Parameter | Symbol | mode | Min | Typ. | Max | Unit | Comment/Condition ^[1] |
|--------------|----------------|--------------|-----|------|-----|------|------------------------------------|
| Output Power | P_{OUT_SPK} | Class-D PWM | | 260 | | mW | @ 3.3V, Load 8 Ω , 1% THD |
| | | | | 640 | | mW | @ 5.0V, Load 8 Ω , 1% THD |
| | | | | 770 | | mW | @ 5.5V, Load 8 Ω , 1% THD |
| | | | | 335 | | mW | @ 3.3V, Load 4 Ω , 10% THD |
| | | | | 840 | | mW | @ 5.0V, Load 4 Ω , 10% THD |
| | | | | 1.00 | | W | @ 5.5V, Load 4 Ω , 10% THD |
| | | Class-AB BTL | | 255 | | mW | @ 3.3V, Load 8 Ω , 0.3% THD |
| | | | | 610 | | mW | @ 5.0V, Load 8 Ω , 0.3% THD |
| | | | | 750 | | mW | @ 5.5V, Load 8 Ω , 0.3% THD |
| | | | | 330 | | mW | @ 3.3V, Load 4 Ω , 10% THD |
| | | | | 800 | | mW | @ 5.0V, Load 4 Ω , 10% THD |
| | | | | 950 | | mW | @ 5.5V, Load 4 Ω , 10% THD |

Notes:

1. $V_{CCA}=V_{CCSPK}$.

5.4.4 SPI Timing

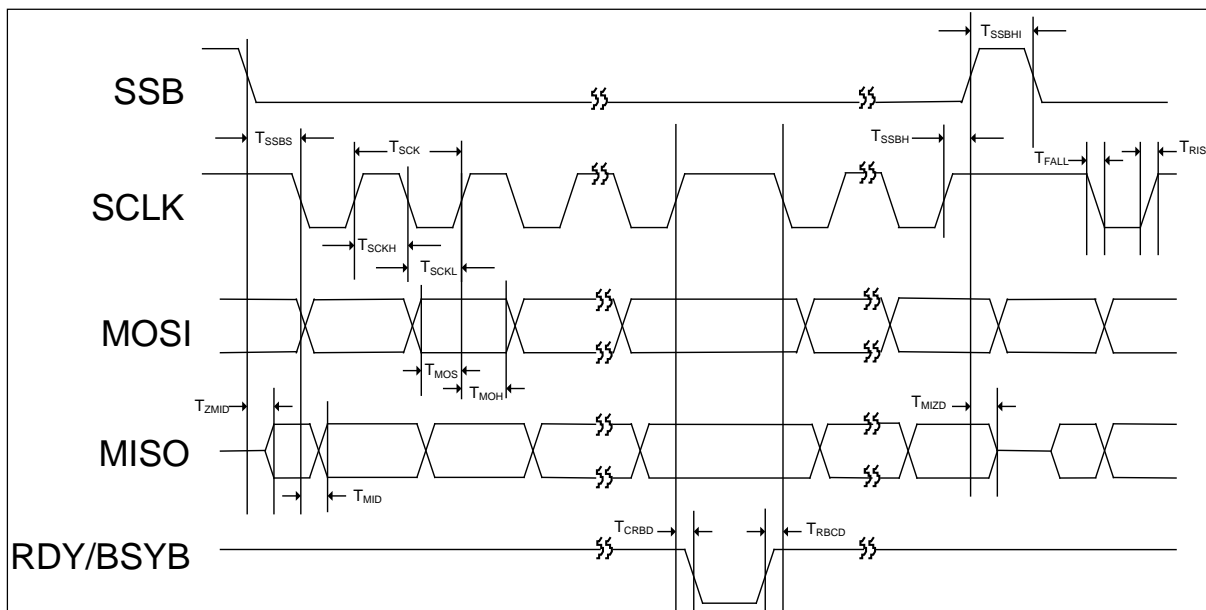


Figure 6-2 SPI Timing

| SYMBOL | DESCRIPTION | MIN | TYP | MAX | UNIT |
|-------------|--|------|-----|------|------|
| T_{SCK} | SCLK Cycle Time | 60 | --- | --- | ns |
| T_{SCKH} | SCLK High Pulse Width | 25 | --- | --- | ns |
| T_{SCKL} | SCLK Low Pulse Width | 25 | --- | --- | ns |
| T_{RISE} | Rise Time for All Digital Signals | --- | --- | 10 | ns |
| T_{FALL} | Fall Time for All Digital Signals | --- | --- | 10 | ns |
| T_{SSBS} | SSB Falling Edge to 1 st SCLK Falling Edge Setup Time | 30 | --- | --- | ns |
| T_{SSBH} | Last SCLK Rising Edge to SSB Rising Edge Hold Time | 30ns | --- | 50us | --- |
| T_{SSBHI} | SSB High Time between SSB Lows | 20 | --- | --- | ns |
| T_{MOS} | MOSI to SCLK Rising Edge Setup Time | 15 | --- | --- | ns |
| T_{MOH} | SCLK Rising Edge to MOSI Hold Time | 15 | --- | --- | ns |
| T_{ZMID} | Delay Time from SSB Falling Edge to MISO Active | -- | -- | 12 | ns |
| T_{MIZD} | Delay Time from SSB Rising Edge to MISO Tri-state | -- | -- | 12 | ns |
| T_{MID} | Delay Time from SCLK Falling Edge to MISO | --- | --- | 12 | ns |
| T_{CRBD} | Delay Time from SCLK Rising Edge to RDY/BSYB Falling Edge | -- | -- | 12 | ns |
| T_{RBCD} | Delay Time from RDY/BSYB Rising Edge to SCLK Falling Edge | 0 | -- | -- | ns |

5.4.5 I²S Timing

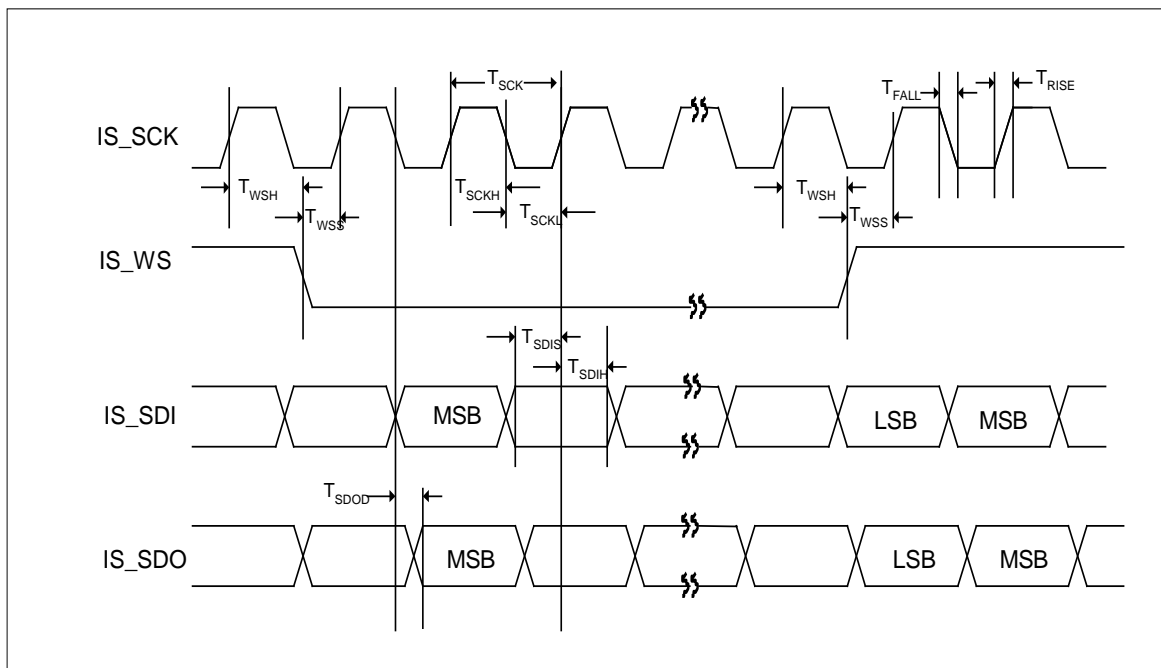


Figure 6-3 I2S Timing

| SYMBOL | DESCRIPTION | MIN | TYP | MAX | UNIT |
|------------|--|-----|-----|-----|------|
| T_{SCK} | IS_SCK Cycle Time | 60 | --- | --- | ns |
| T_{SCKH} | IS_SCK High Pulse Width | 25 | --- | --- | ns |
| T_{SCKL} | IS_SCK Low Pulse Width | 25 | --- | --- | ns |
| T_{RISE} | Rise Time for All Digital Signals | --- | --- | 10 | ns |
| T_{FALL} | Fall Time for All Digital Signals | --- | --- | 10 | ns |
| T_{WSS} | WS to IS_SCK Rising Edge Setup Time | 20 | --- | --- | ns |
| T_{WSH} | IS_SCK Rising Edge to IS_WS Hold Time | 20 | --- | --- | ns |
| T_{SDIS} | IS_SDI to IS_SCK Rising Edge Setup Time | 15 | --- | --- | ns |
| T_{SDIH} | IS_SCK Rising Edge to IS_SDI Hold Time | 15 | --- | --- | ns |
| T_{SDOD} | Delay Time from IS_SCLK Falling Edge to IS_SDO | --- | --- | 12 | ns |

7. APPLICATION DIAGRAM

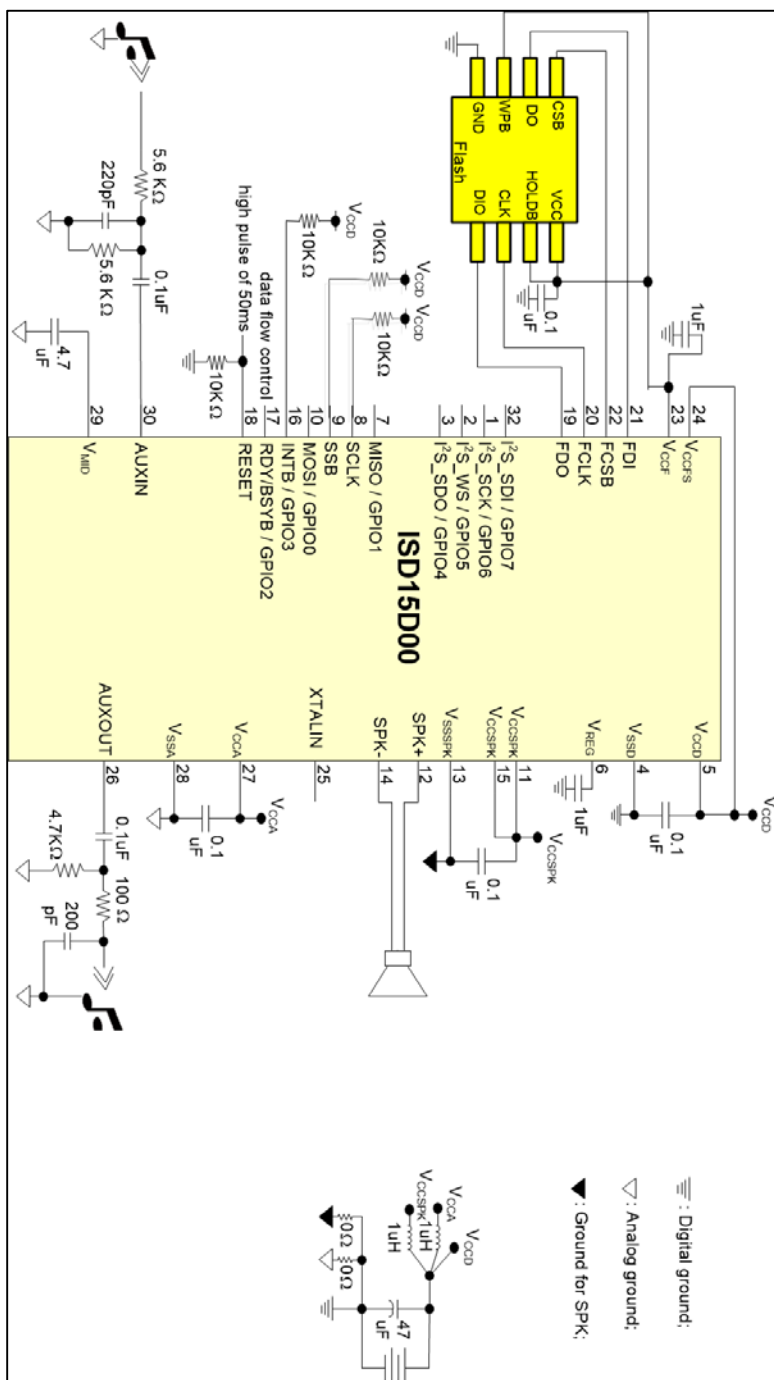


Figure 7-1 ISD15D00 Application Diagram – V_{CCF} is regulated internally from V_{CCFS}

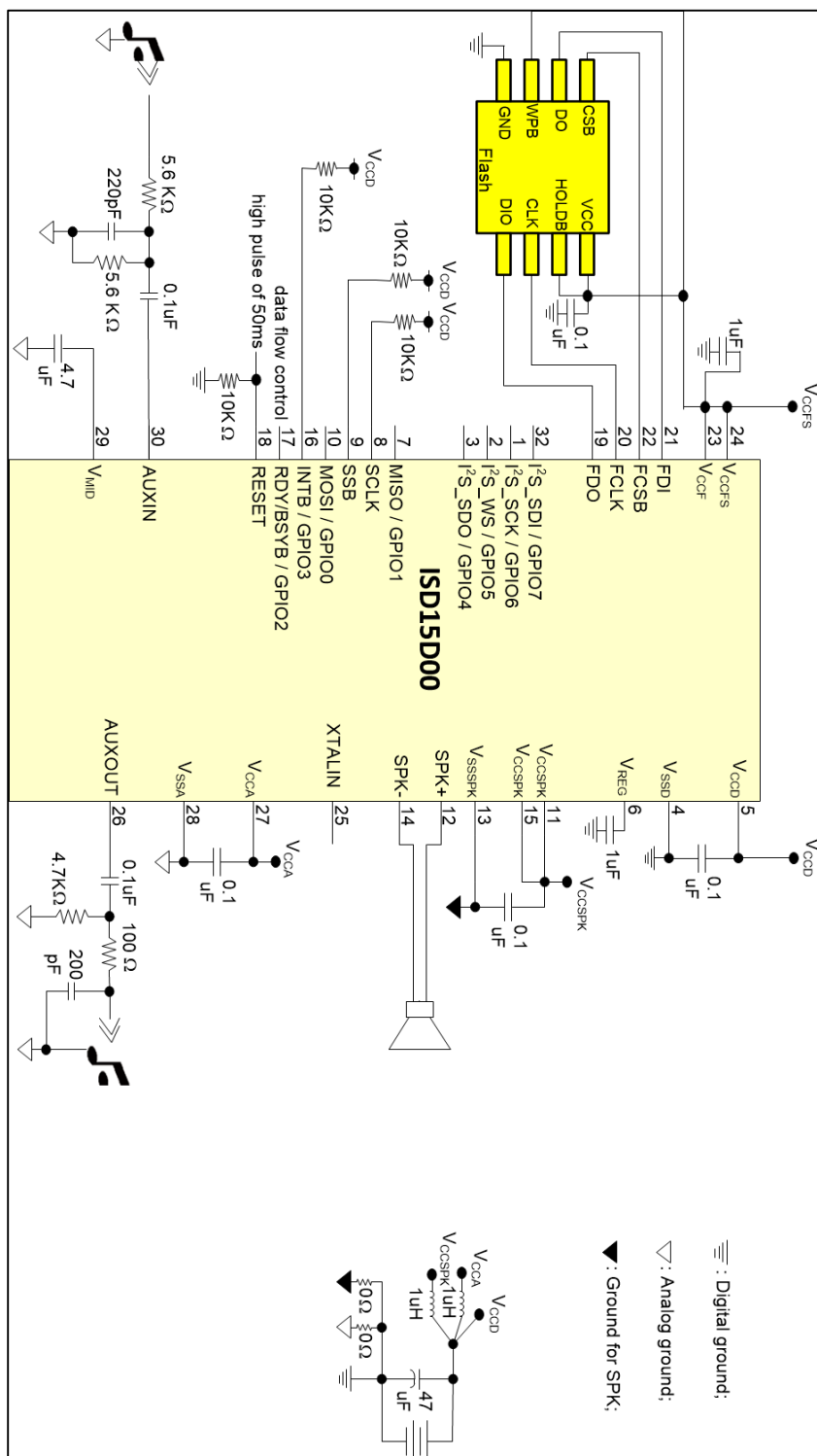


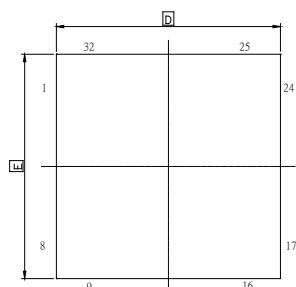
Figure 7-2 ISD15D00 Application Diagram – VCCF is tied to VCCFS

The above application examples are for references only. It makes no representation or warranty that such applications shall be suitable for the use specified. Each design has to be optimized in its own system for the best performance on voice quality, current consumption, functionalities and etc.

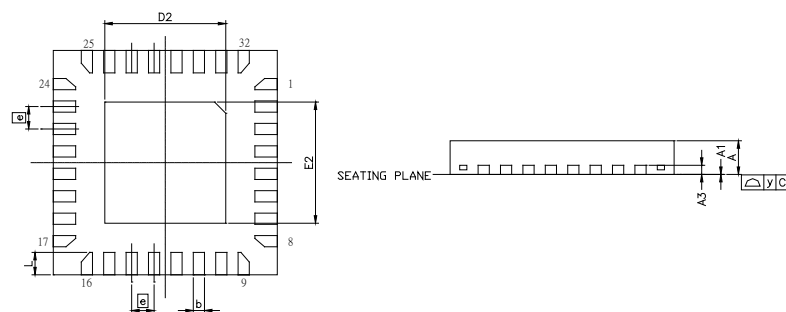
8. PACKAGE SPECIFICATION

8.1 32 LEAD QFN (5X5 MM², THICKNESS 0.8MM ,PITCH 0.5 MM)

TOP VIEW

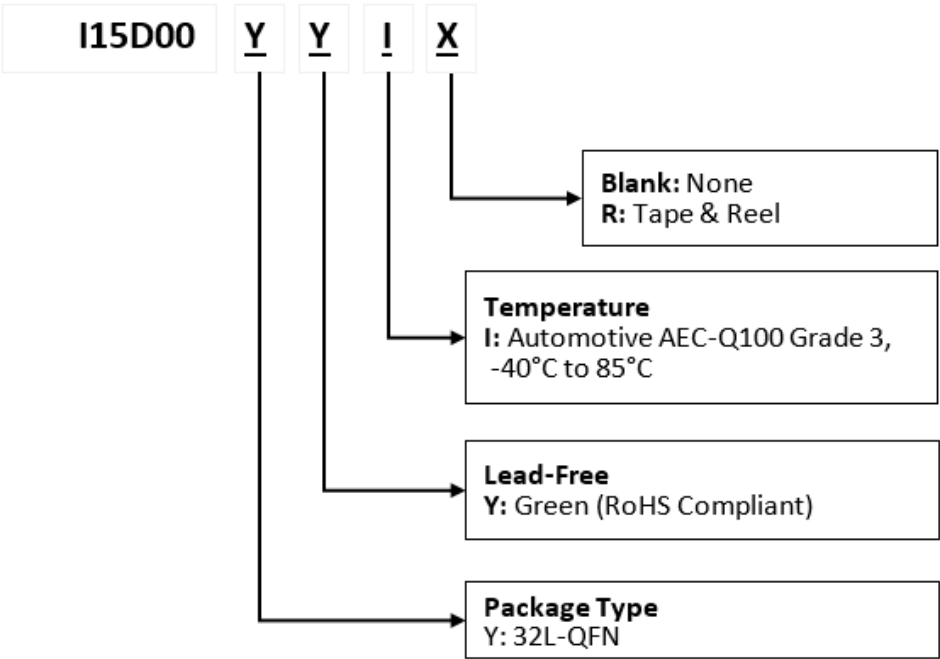


BOTTOM VIEW



| SYMBOL | DIMENSION (MM) | | | DIMENSION (INCH) | | |
|--------|----------------|------|------|------------------|--------|--------|
| | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. |
| A | 0.70 | 0.75 | 0.80 | 0.0275 | 0.0295 | 0.0315 |
| A1 | 0 | 0.02 | 0.05 | 0 | 0.001 | 0.002 |
| A3 | 0.20 REF | | | 0.008 REF | | |
| b | 0.18 | 0.25 | 0.30 | 0.007 | 0.010 | 0.012 |
| D | 5.00 BSC | | | 0.197 BSC | | |
| D2 | 2.60 | 2.70 | 2.80 | 0.1024 | 0.1063 | 0.1102 |
| E | 5.00 BSC | | | 0.197 BSC | | |
| E2 | 2.60 | 2.70 | 2.80 | 0.1024 | 0.1063 | 0.1102 |
| e | 0.50 BSC | | | 0.0197 BSC | | |
| L | 0.30 | 0.40 | 0.50 | 0.012 | 0.016 | 0.020 |
| y | 0.10 | | | 0.0039 | | |

9. ORDERING INFORMATION



| Part Number | Duration | Package | Temperature | Notes |
|-------------|---------------------------------|-------------------------|--|-------|
| I15D00YYI | Ext. Flash 128Mbit / 64 Minutes | 32L-QFN | Automotive AEC-Q100 Grade 3 -40°C to 85°C | |
| I15D00YYIR | Ext. Flash 128Mbit / 64 Minutes | 32L-QFN, Tape & Reel | Automotive AEC-Q100 Grade 3 -40°C to 85°C | |

10. REVISION HISTORY

| Version | Date | Description |
|---------|--------------|---|
| 1.0 | Aug 23, 2013 | Add internal oscillator characteristics. |
| 1.1 | Jun 13, 2014 | Update current consumption characteristic data |
| 1.2 | Aug 3, 2016 | Add Absolute Maximum Ratings. Add Talarm temperature threshold typical value. |
| 1.3 | Mar 27, 2020 | Update Document Format |
| 1.4 | May 21, 2021 | Update Package Information |
| 1.5 | May 24, 2021 | Update Ordering info part number |
| 1.6 | Jun 15, 2021 | Update Ordering Information Update output power Remove buzzer description |

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